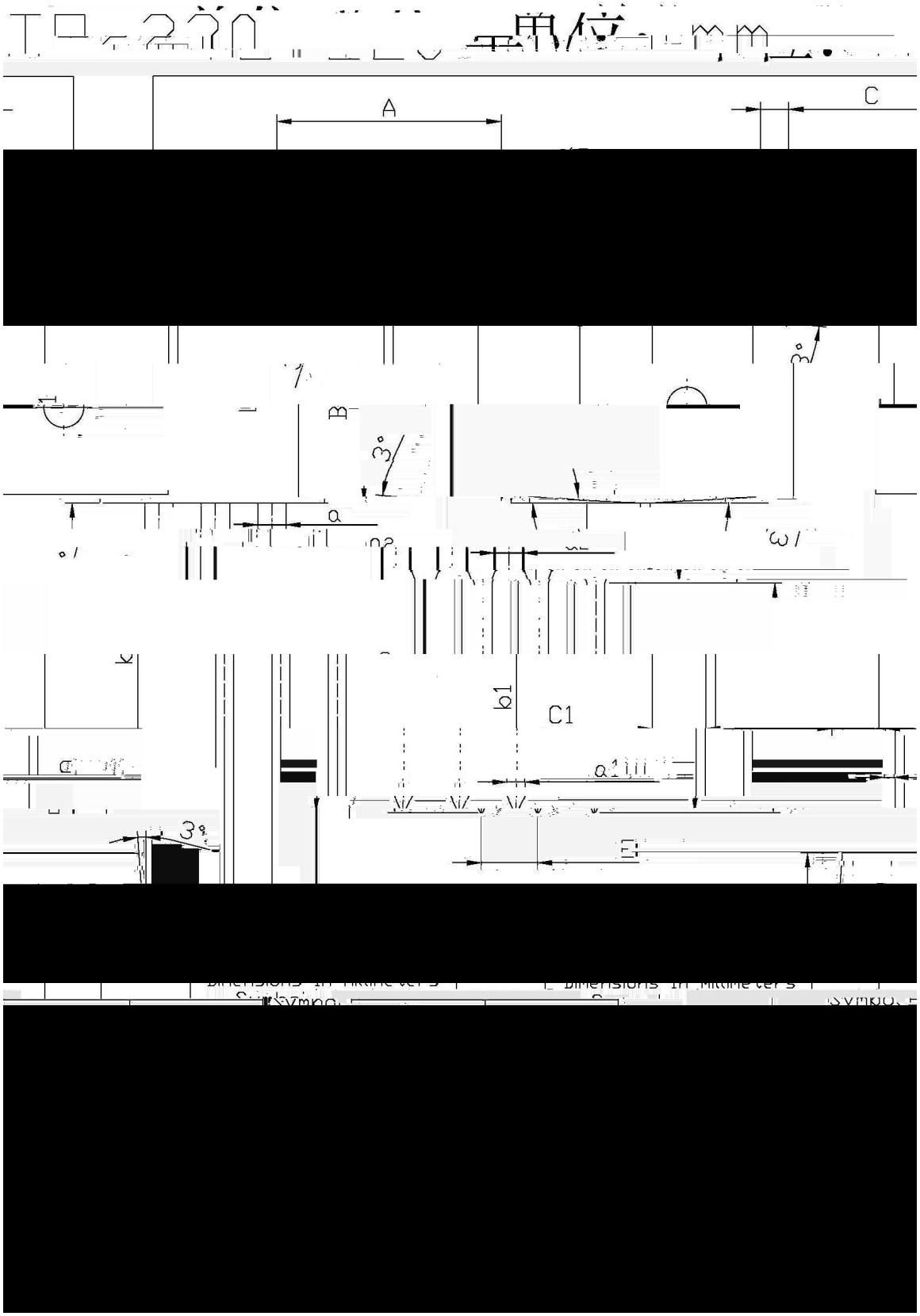
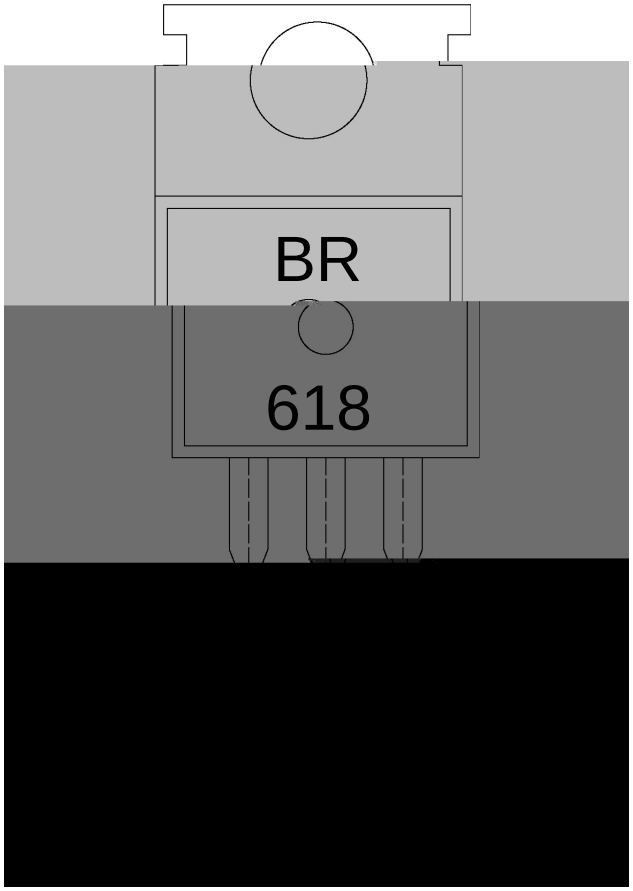
/ Package Dimensions



/ Marking Instructions



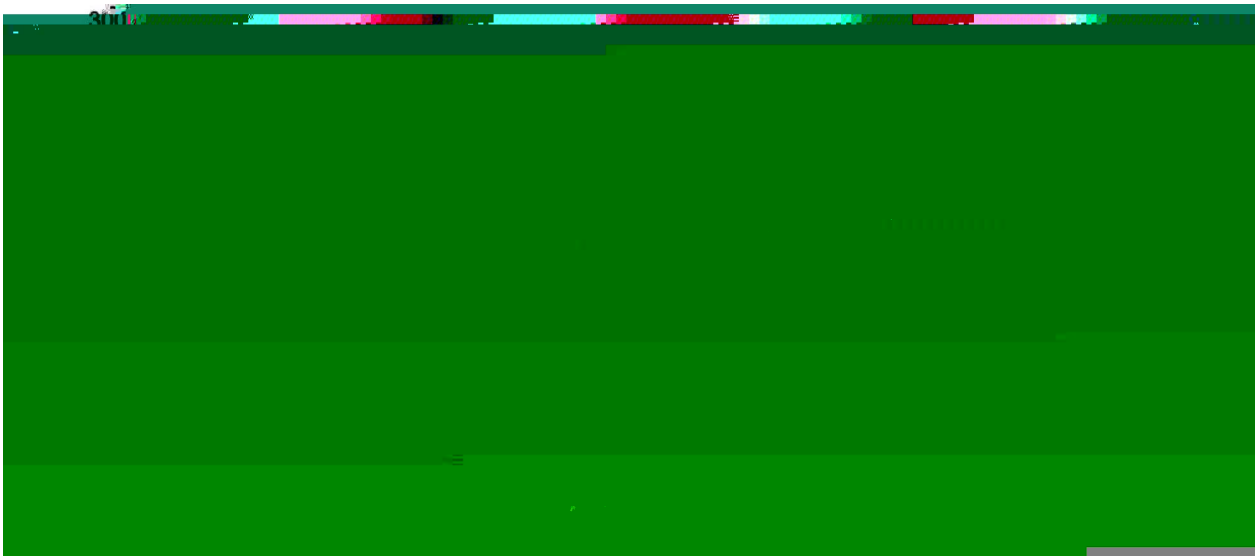
ب ˝ χ

BR χ	⌘ ⅔ ᴵᴵ ⅂
618 χ	⌘ ⅋ ᴺ ⅂
---- χ	⌘ ⅃ ⅎ ᴴ ᴺ ⅂ ⅃ ⅋ ⅃ ⅎ ᴴ ᴺ ⅄ ⅂

Note:

BR:	Company Code
618:	Product Type.
****:	Lot No. Code, code change with Lot No.

( ) / Temperature Profile for Dip Soldering(Pb-Free)



ب ˝ χ

1 ǂ ♬ □ ỷ 25 Ḱ 150 ɬ ı `H ڑ 60 Ḱ 90sec;

2 Š Ö □ ỷ 255 ° 5 ɬ ı `H ڑ ˋY ⺈ ⺾ 5 ° 0.5sec;

3 ì ˙ ⺈ ˛ ɔ ھ ỷ ⺾ 2 Ḱ 10 ɬ /sec.

Note:

1.Preheating:25~150 ɬ , Time:60~90sec.

2.Peak Temp.:255 ° 5 ɬ , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ɬ /sec.

/ Resistance to Soldering Heat Test Conditions

□ ỷ χ 270 ° 5 ɬ `H ڑ χ 10 ° 1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

ˋΩ̣ τ̣ γ ⊢ / BULK

Package Type	Units					Dimension		(unit mm^3)

˝ ⺈ γ ⊢ / TUBE

Package Type	Units					Dimension		(unit mm^3)

/ Notices